



D18V0L1B2LP

18V BIDIRECTIONAL TVS DIODE

Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±20kV, Contact ±15kV
- 1 Channel of ESD Protection
- High Peak Pulse Current per IEC 61000-4-5 Standard
- Typically Used in Cellular Handsets, Portable Electronics, Communication Systems, Computers and Peripherals
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X1-DFN1006-2
- Low Profile Package (0.53mm max) and Ultra-small PCB Footprint Area (1.08 x 0.68mm max) Suitable for Compact Portable Electronics
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208 @4)
- Weight: 0.001 grams (approximate)

X1-DFN1006-2







Device Schematic

Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D18V0L1B2LP-7B	AEC-Q101	SE	7	8	10.000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



SE = Product Type Marking Code Line Denotes Pin 1

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_{PP}	68	W	8/20µs, Per Figure 3
Peak Pulse Current	I _{PP}	2.0	Α	8/20µs, Per Figure 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±15	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V_{ESD_Air}	±20	kV	IEC 61000-4-2 Standard

D18V0L1B2LP Document number: DS36461 Rev. 1 - 2

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Thermal Characteristics

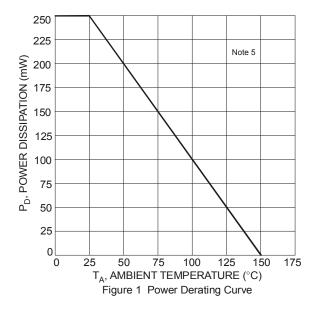
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

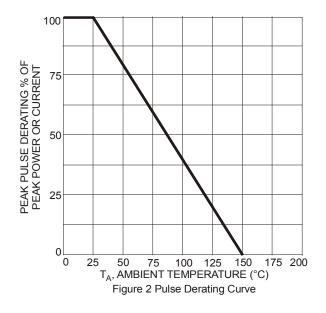
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	_	_	18	V	_
Channel Leakage Current (Note 6)	I _{RM}	_	_	100	nA	V _{RWM} = 18V
Clamping Voltage, Positive Transients	V _{CL}	_	27	30	V	$I_{PP} = 1A, t_p = 8/20 \mu S$
Clamping Voltage, Positive Transients		_	30	34	V	$I_{PP} = 2A, t_p = 8/20\mu S$
Breakdown Voltage	V _{BR}	21	_	25	V	I _R = 1mA
Differential Resistance	R _{DIF}	_	2.2	_	Ω	$I_R = 1A, t_p = 8/20\mu S$
Channel Input Capacitance	C _T	_	7.0	12	pF	V _R = 0V, f = 1MHz

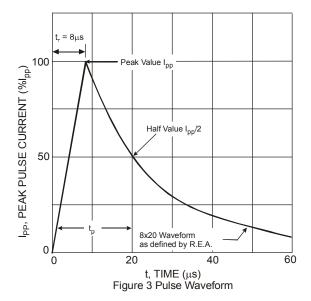
Notes

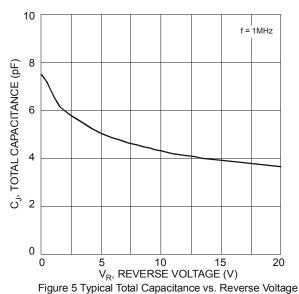
- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.

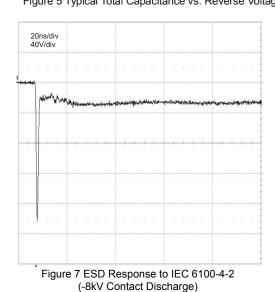


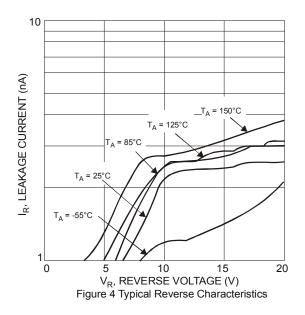












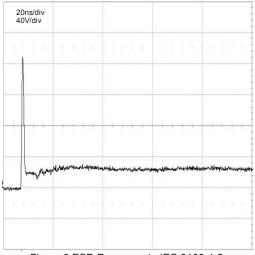
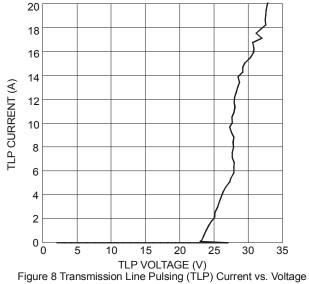


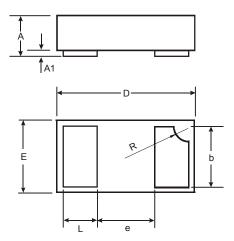
Figure 6 ESD Response to IEC 6100-4-2 (+8kV Contact Discharge)





Package Outline Dimensions

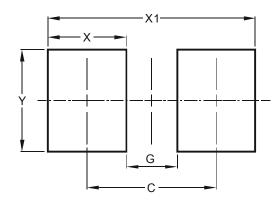
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



X1-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0	0.05	0.03		
b	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е	-	-	0.40		
L	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.70
G	0.30
Х	0.40
X1	1.10
Υ	0.70



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